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11-02-1999



RECORDATION FORM COVER S.

101187892

Docket: 0819-300

To the Honorable Assistant Commissioner for Patent. Please record the attached original documents or copy thereof.

JC 025 U. S. PTO  
09/420455  
10/18/99

1. Name of conveying party: Seiji SOGO  
Additional name(s) of conveying party(ies) attached? [ ] Yes [X] No

2. Name and address of receiving party:  
Name: Matsushita Electronics Corporation  
Street Address: 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan  
City \_\_\_\_\_ State \_\_\_\_\_ ZIP \_\_\_\_\_  
Additional name(s) & addresses(es) attached? [ ] Yes [X] No

3. Name of Conveyance:  
[X] Assignment [ ] Merger  
[ ] Security Agreement [ ] Change of Name  
[ ] Other \_\_\_\_\_  
Execution Date: October 14, 1999

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is: October 14, 1999  
Title: SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

10/26/1999 TRADE1 A 00000007 192380 09420455 B. Patent No.(s)  
Additional numbers attached? \_\_\_ Yes \_\_\_ No 09/420455  
03 FC:581 40.00 CH

5. Name and address of party to whom correspondence document should be mailed:  
Name: SIXBEY, FRIEDMAN, LEEDOM & FERGUSON, P.C.  
Street Address: 8180 Greensboro Drive, Suite 800  
City: McLean State: Virginia ZIP 22102

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): .....\$40.00  
[X] Enclosed  
[ ] Authorized to be changed to deposit account

8. Deposit Account Number: \_\_\_\_\_  
(Attach duplicate copy of this page if paying by deposit account)

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02 FC:581 Statement and signature. 40.00 OP  
03 FC:139 130.00 CH

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Eric J. Robinson

10/18/99

Date

Void after 10/26/1999 TRADE1  
10/26/1999 TRADE1 00000007 192380 09420455  
02 FC:581 -40.00 OP  
03 FC:139 130.00 CR

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

WHEREAS, Seiji SOGO (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME for which an application for Letters Patent of the United States of America has been executed by the undersigned on October 14, 1999, and;

WHEREAS, Matsushita Electronics Corporation of 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Sixbey, Friedman, Leedom & Ferguson, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

*In witness thereof*, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date October 14, '99, Name of Inventor Seiji SOGO (SEAL)  
Seiji SOGO

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

Date \_\_\_\_\_, Name of Inventor \_\_\_\_\_ (SEAL)

(This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.)

Witness \_\_\_\_\_ (name) \_\_\_\_\_ (signature)

Witness \_\_\_\_\_ (name) \_\_\_\_\_ (signature)